

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









RGF1A, RGF1B, RGF1D, RGF1G, RGF1J, RGF1K, RGF1M

Vishay General Semiconductor

Surface Mount Glass Passivated Junction Fast Switching Rectifier

SUPERECTIFIER®



DO-214BA (GF1)

PPRIMARY CHARACTERISTICS							
I _{F(AV)} 1.0 A							
V_{RRM}	50 V, 100 V, 200 V, 400 V, 600 V, 800 V, 1000 V						
I _{FSM}	30 A						
V_{F}	1.3 V						
t _{rr}	150 ns, 250 ns, 500 ns						
T _J max.	175 °C						
Package	DO-214BA (GF1)						
Diode variations	Single						

TYPICAL APPLICATIONS

For use in fast switching rectification of power supply, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

FEATURES





· Fast switching for high efficiency

· Low leakage current

• High forward surge capability

 Meets MSL level 1, per J-STD-020, LF maximum peak of 250 °C

AEC-Q101 qualified

 Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

MECHANICAL DATA

Case: DO-214BA, molded epoxy over glass body
Molding compound meets UL 94 V-0 flammability rating
Base P/N-E3 - RoHS-compliant, commercial grade
Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Two bands indicate cathode end - 1st band denotes device type and 2nd band denotes repetitive peak reverse voltage rating

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)									
PARAMETER	SYMBOL	RGF1A	RGF1B	RGF1D	RGF1G	RGF1J	RGF1K	RGF1M	UNIT
Device marking code		RA	RB	RD	RG	RJ	RK	RM	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at T _L = 120 °C	I _{F(AV)}	1.0					Α		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30					Α		
Maximum full load reverse current, full cycle average $T_A = 55^{\circ}\text{C}$	I _{R(AV)}	50					μΑ		
Operating junction and storage temperature range	T _J , T _{STG}	- 65 to + 175						°C	



RGF1A, RGF1B, RGF1D, RGF1G, RGF1J, RGF1K, RGF1M

www.vishay.com

Vishay General Semiconductor

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)											
PARAMETER	TEST CONDITIONS		SYMBOL	RGF1A	RGF1B	RGF1D	RGF1G	RGF1J	RGF1K	RGF1M	UNIT
Maximum instantaneous forward voltage	1.0 A		V _F	1.3					V		
Maximum DC reverse current at rated DC		T _A = 25 °C								μA	
blocking voltage		T _A = 125 °C	l _R	100							μΛ
Typical reverse recovery time	I _F = 0.5 I _{rr} = 0.2	A, I _R = 1.0 A, 5 A	t _{rr}	150 250 500					00	ns	
Typical junction capacitance	4.0 V, 1	MHz	CJ	8.5				pF			

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)									
PARAMETER SYMBOL RGF1A RGF1B RGF1D RGF1G RGF1J RGF1K RGF1M UNI								UNIT	
Typical thormal resistance	R _{0JA} (1)	80							°C/W
Typical thermal resistance	R _{0,JL} (1) 28					C/VV			

Note

⁽¹⁾ Thermal resistance from junction to ambient and from junction to lead, PCB mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
RGF1J-E3/67A	0.104	67A	1500	7" diameter plastic tape and reel				
RGF1J-E3/5CA	0.104	5CA	6500	13" diameter plastic tape and reel				
RGF1JHE3/67A (1)	0.104	67A	1500	7" diameter plastic tape and reel				
RGF1JHE3/5CA (1)	0.104	5CA	6500	13" diameter plastic tape and reel				

Note

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

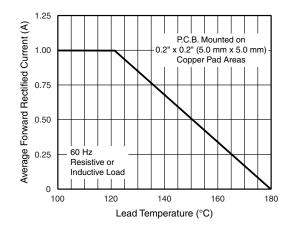


Fig. 1 - Forward Current Derating Curve

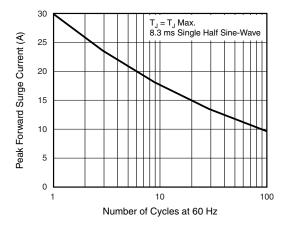


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

⁽¹⁾ AEC-Q101 qualified



RGF1A, RGF1B, RGF1D, RGF1G, RGF1J, RGF1K, RGF1M

www.vishay.com

Vishay General Semiconductor

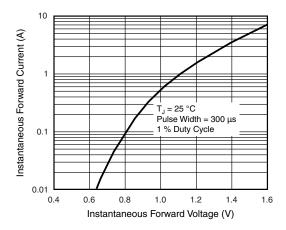


Fig. 3 - Typical Instantaneous Forward Characteristics

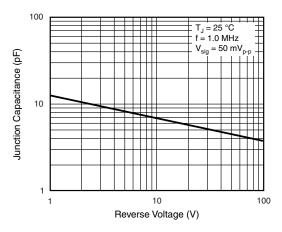


Fig. 5 - Typical Junction Capacitance

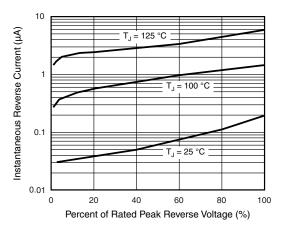


Fig. 4 - Typical Reverse Characteristics

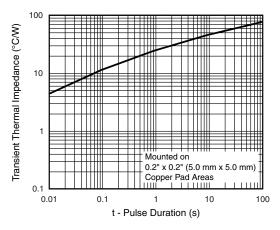


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214BA (GF1) Cathode Band **Mounting Pad Layout** 0.076 (1.93) 0.066 (1.68) 0.066 (1.68) MAX. 0.040 (1.02) MIN. 0.187 (4.75) 0.167 (4.24) 0.015 (0.38) 0.0065 (0.17) 0.060 (1.52) MIN. 0.108 (2.74) 0.118 (3.00) 0.100 (2.54) 0.098 (2.49) 0.220 (5.58) REF. 0.114 (2.90) 0.006 (0.152) TYP 0.060 (1.52) 0.094 (2.39) 0.030 (0.76) 0.226 (5.74) 0.196 (4.98)



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.